## **Product Data Sheet**

# DIAION<sup>™</sup> SKT10L

DIAION™ SKT10L is a gel type strongly acidic cation exchange resin. It has standard cross-linkages and shows lower TOC leakage. It is recommended for UPW application.

Product		
Grade Name		DIAION <sup>TM</sup> SKT10L
Туре		Strong Acid Cation
Matrix		Styrene-DVB, Gel
Functional Group		Sulfonic acid
lonic Form		H⁺
Specification		
Color and Shape	-	<b>Brown Translucent Beads</b>
Salt Splitting Capacity	meq/mL	1.7 min.
Water Content	%	50 - 60
Particle Size Distribution on 1180 μm	%	5 max.
Particle Size Distribution thr. 425 $\mu m$	%	1 max.
Effective Size	mm	0.45 min.
Uniformity Coefficient	-	1.6 max.
Ionic Form Conversion (H <sup>+</sup> )	eq%	99.9 min.
ΔΤΟC	ppb	20 max.
Outlet Resistivity	MΩ•cm	12 min.
Typical Properties		
Shipping Density	g/L	790
Mean Particle Size	μm	710
Particle Density	g/mL	1.20

Total Swelling (Na<sup>+</sup> to H<sup>+</sup>)



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## **Recommended Operating Conditions**

120	°C	Maximum Operating Temperature
0 - 14		Operating pH Range
800	mm	Minimum Bed Depth
10 - 40	m/h	Service Flow Rate
HCI		Regenerant
$H_2SO_4$		
HCl 4 - 10	%	Regenerant Concentration
H <sub>2</sub> SO <sub>4</sub> 1 - 4		
30 - 150	g/L	Regenerant Level
2 - 10	m/h	Regenerant Flow Rate
2 - 10	BV	Total Rince Requirement



### **Hydraulic Characteristics**

The approximate pressure drop at various temperatures and flow rates for each meter of bed depth of  $\mathsf{DIAION}^\mathsf{TM}$  SKT10L resin in normal down flow operation is shown in the graphs below.

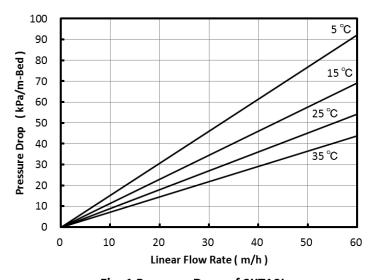


Fig. 1 Pressure Drop of SKT10L

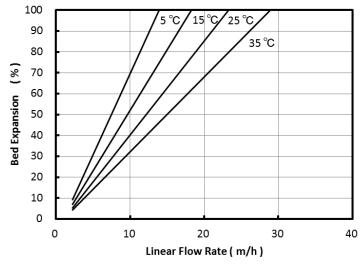


Fig. 2 Bed Expansion of SKT10L



#### Rinse Performance

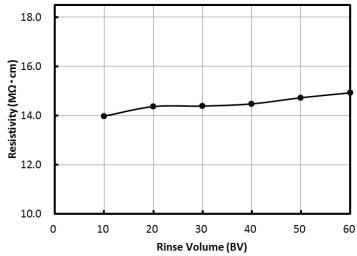


Fig. 3 Resistivity versus Rinse Volume for SKT10L Flow rate: SV 20 (10 L/hr), Resin volume: 500 mL-R

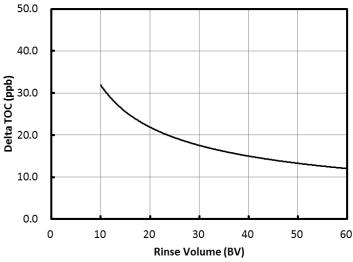


Fig. 4 Delta TOC versus Rinse Volume for SKT10L Flow rate: SV 20 (10 L/hr), Resin volume: 500 mL-R

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